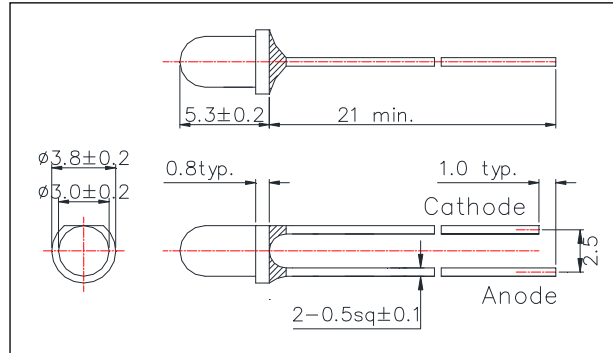


L1450S-33
Infrared LED LAMP

<Specifications>

- Chip Material: InGaAsP
- Chip Dimension: 300um x 300um
- Number of Chips: 1pcs
- Peak Wavelength: 1450nm typ.
- Package Type: Φ5mm Clear Molding
- Lead Frame: Soldered (Lead Free)
- Lens: Epoxy Resin

Outer Dimension (Unit:mm)



Absolute Maximum Ratings[Tc=25°C]			
Item	Symbol	Value	Unit
Power Dissipation	PD	130	mW
Forward Current	IF	100	mA
Pulse Forward Current*	IFP	1000	mA
Reverse Voltage	VR	5	V
Thermal Resistance	Rthja	250	K/W
Junction Temperature	Tj	120	°C
Operating Temperature	TOPR	-40 ~ +100	°C
Storage Temperature	TSTG	-40 ~ +100	°C
Soldering Temperature*	TSOL	265	°C

* Duty=1% and Pulse Width=10μs

** Soldering condition must be completed within 3 second at 265 °C.

Electro-Optical Characteristics [Ta=25°C]						
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	VF	IF=50mA		0.9	1.3	V
	VFP	IFP=1A		1.7		
Total Radiated Power*	PO	IF=50mA		4.8		mW
		IFP=1A		30		
Radiant Intensity**	IE	IF=50mA		21		mW/sr
		IFP=1A		130		
Peak Wavelength	λP	IF=50mA	1400		1500	nm
Half Width	Δλ	IF=50mA		110		nm
Viewing half Angle	θ1/2	IF=50mA		±23		deg
Rise Time	tr	IF=50mA		30		ns
Fall Time	tf	IF=50mA		70		ns

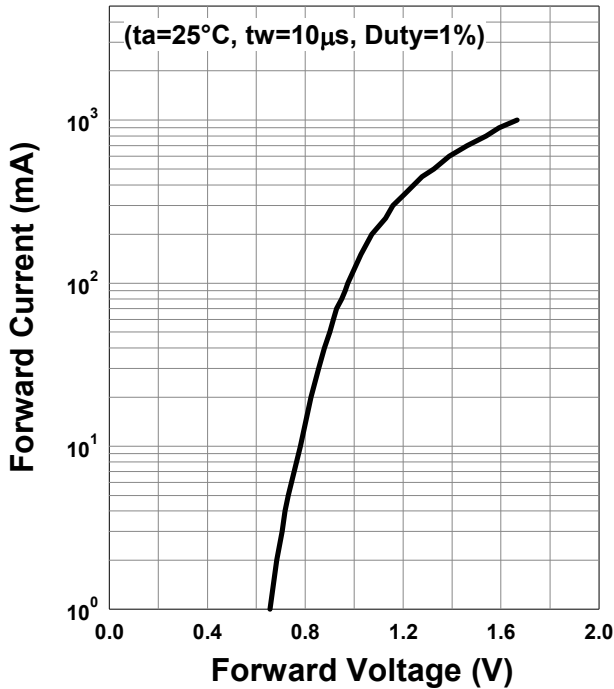
* Measured by G8370-85

** Measured by Ando Optical Mutil Meter AQ2140 & AQ2742

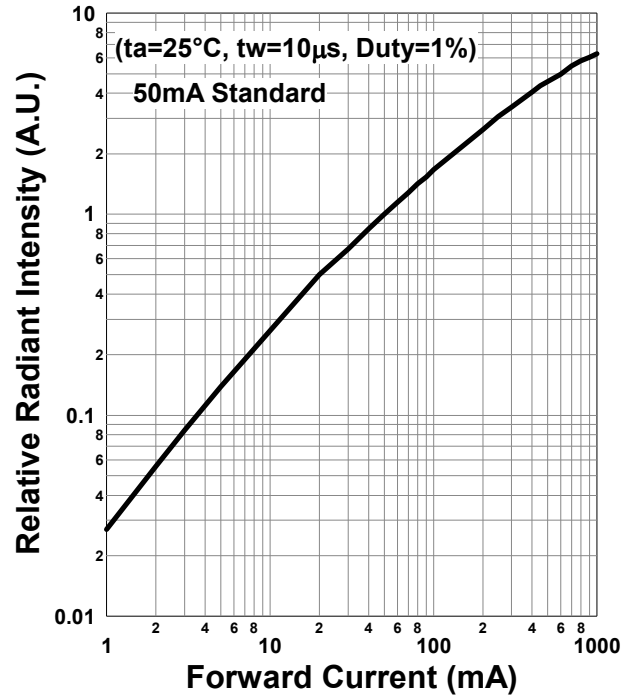


Typical Characteristic Curves

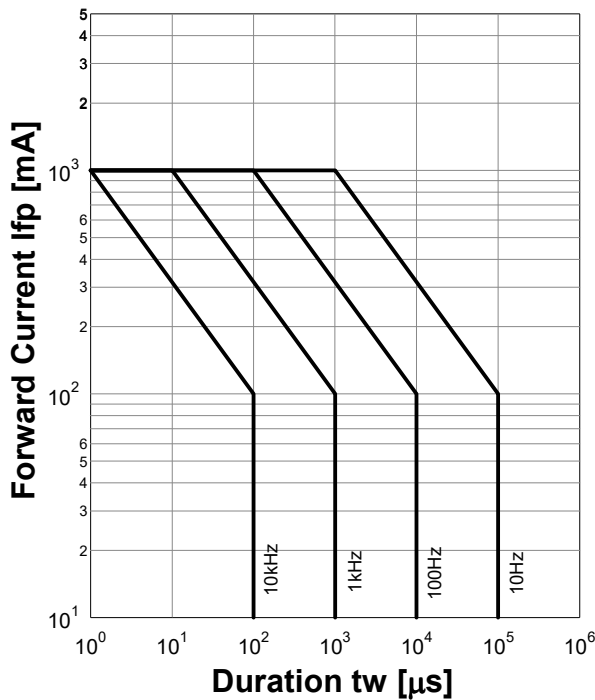
Forward Current - Forward Voltage



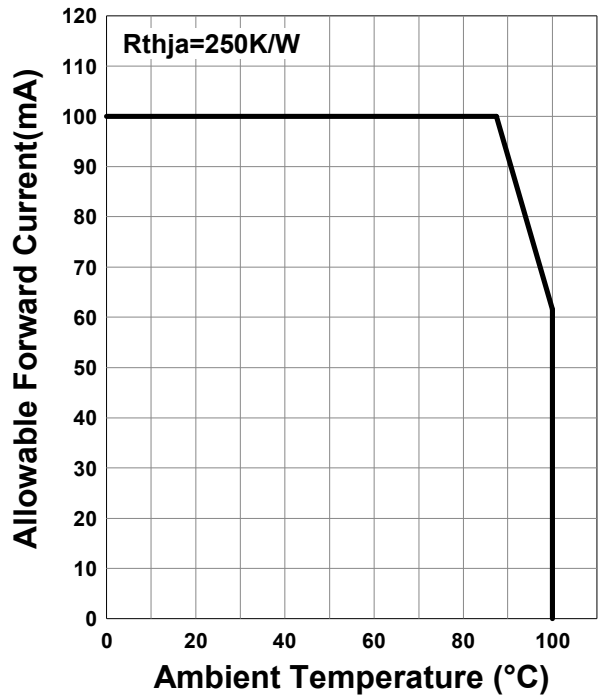
Relative Radiant Intensity - Forward Current

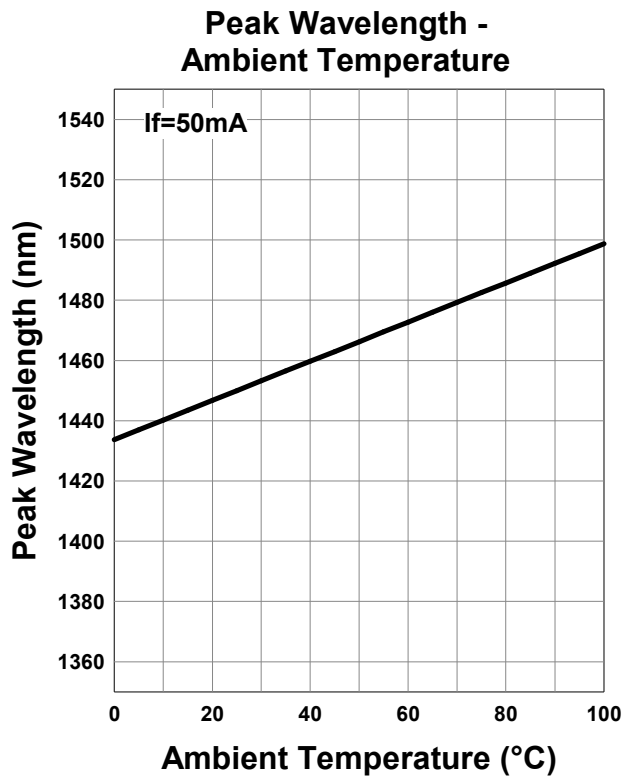
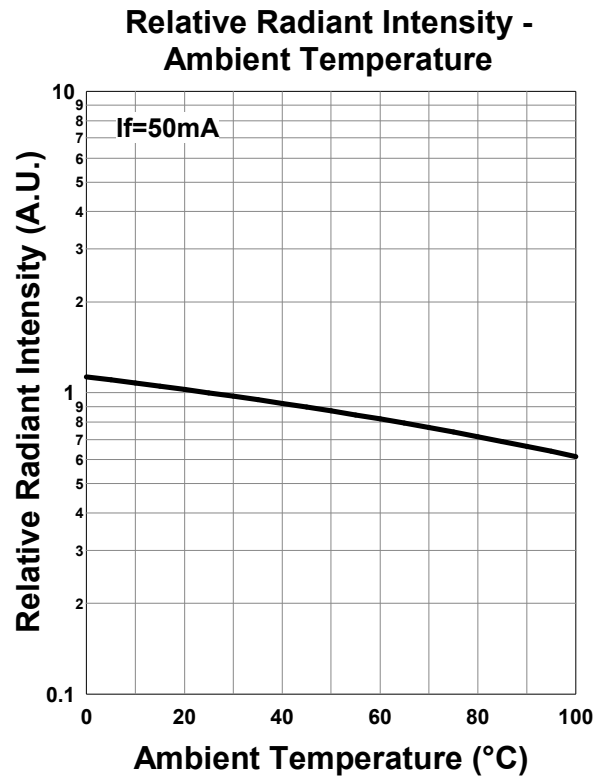
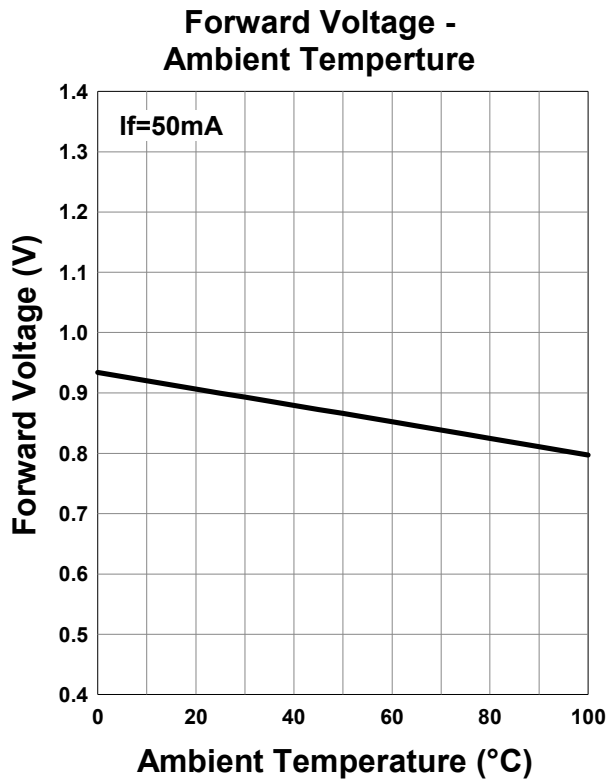


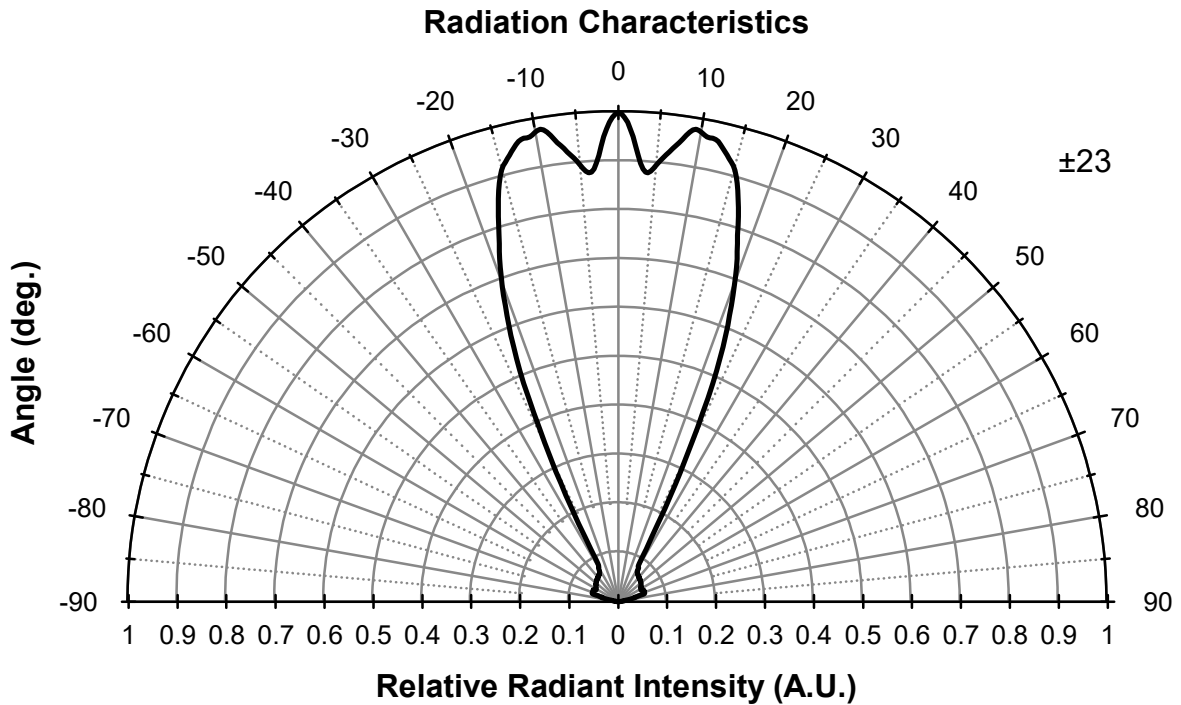
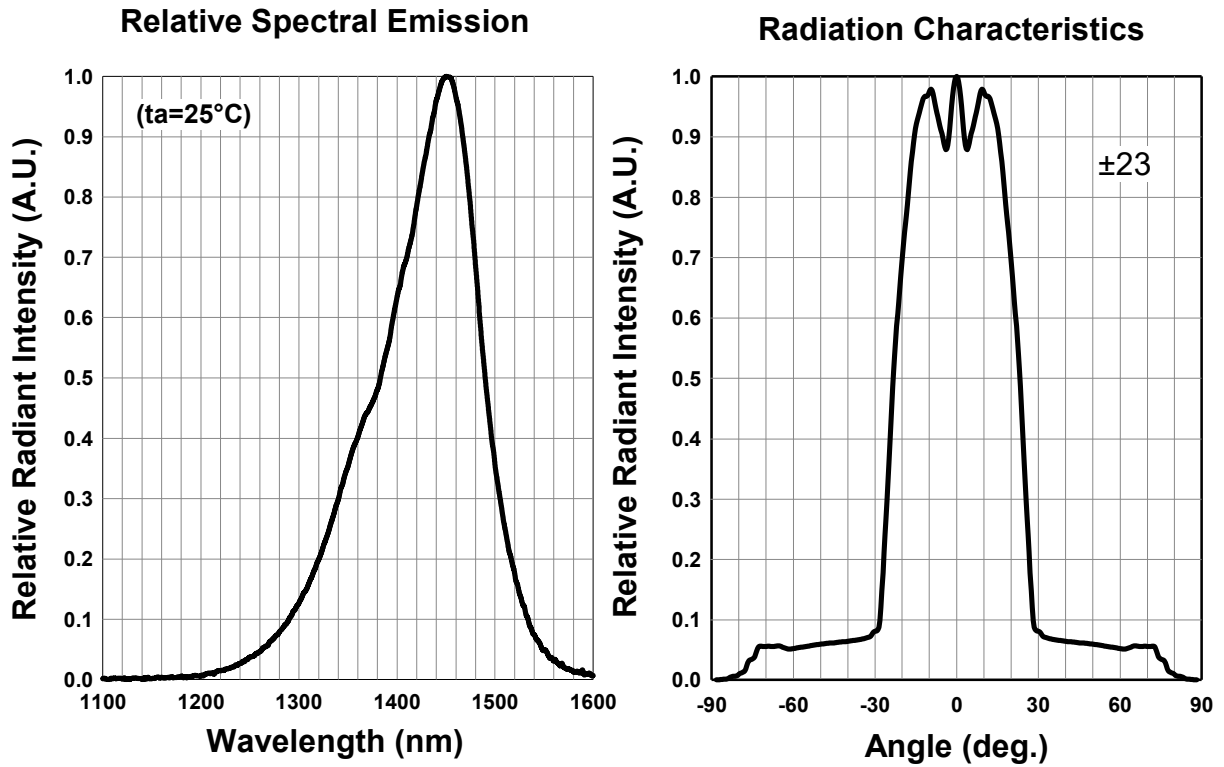
Forward Current - Pulse Duration



Allowable Forward Current - Ambient Temperature







Disclaimer

Product specifications and data shown in this product catalog are subject to change without notice for the purposes of improving product performance, reliability, design, or otherwise.

Product data and parameters in this catalog are typical values based on reasonably up-to-date measurements.

Product data and parameters may vary by user application and over time.

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2018.04